

R2A20124AFP/R2A20124ASP

R03DS0031EJ0300 Rev.3.00 Mar 11, 2011

Synchronous Phase Shift Full-Bridge Control IC Series

Description

The R2A20124AFP/R2A20124ASP controls a full-bridge phase shift circuit and secondary synchronous rectification. The R2A20124AFP/R2A20124ASP has adjustable delay time functions which make ZVS of primary side and make loss of body diode of primary switching device minimal.

The R2A20124AFP/R2A20124ASP is based on HA16163/R2A20121. And RAMP slope compensation circuit is builtin as an additional function. Also its output driver circuits are improved to enlarge gate drive output voltage swing from VREF to VCC.

In addition R2A20124AFP has ON/OFF function of synchronous rectification and includes amplifier which detect input current signal.

Features

- Maximum ratings
 - Supply voltage Vcc: 20 V
 - Operating junction temperature Tj-opr: -40 to +125°C
- Electrical characteristics
 - VFB feedback voltage VFB(-): 1.25 V \pm 2.0%
 - UVLO (Under Voltage Lockout) operation start voltage VH: $8.4 \text{ V} \pm 0.7 \text{ V}$
 - UVLO operation shutdown voltage VL: $8.0 \text{ V} \pm 0.6 \text{ V}$
 - UVLO hysteresis voltage dVUVL: $0.4 \text{ V} \pm 0.1 \text{ V}$
 - Output voltage swing of OUT-A, B, C, D, and E for gate drive: GND to VCC
- Functions

R2A20124AFP/R2A20124ASP

- Full-bridge phase-shift switching circuit with adjustable delay times
- Pulse by pulse current limit
- Synchronization I/O for the oscillator
- Ramp sloping adjustor
- Error amplifier built-in
- Soft start function

R2A20124AFP

- Synchronous rectification on/off control
- Remote on/off control
- Amplified output of current sense input voltage: CS
- · Package lineup
 - Pb-free LQFP-40: R2A20124AFP
 - Pb-free SOP-20: R2A20124ASP

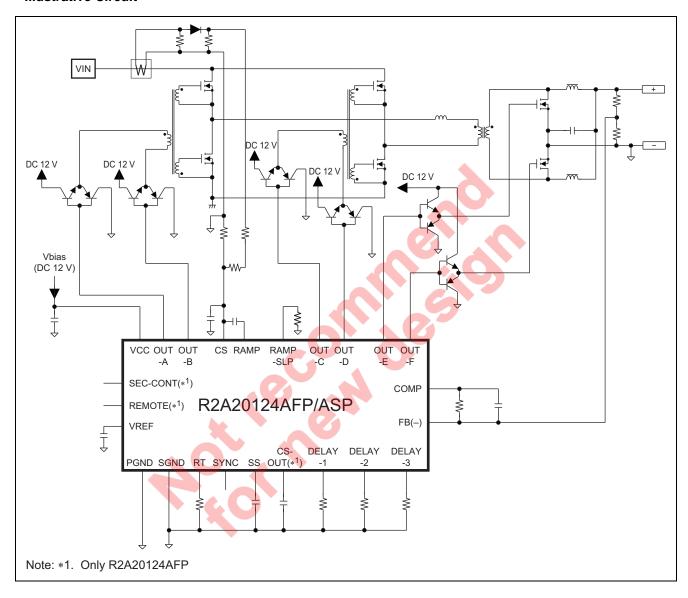
Ordering Information

Part No.	Package Name	Package Code	Taping Spec.
R2A20124AFP-W0	FP-40EV	PLQP0040JB-C	2000 pcs./one taping product
R2A20124AFP-W5			2000 pcs./one taping product
R2A20124AFP-U0			_
R2A20124AFP-U5			_
R2A20124ASP-W0	FP-20DAV	PRSP0020DD-B	2000 pcs./one taping product
R2A20124ASP-W5			2000 pcs./one taping product
R2A20124ASP-U0			_
R2A20124ASP-U5			_

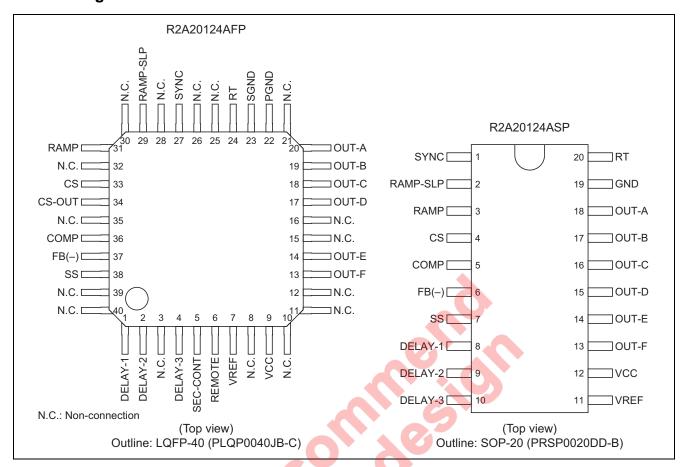
Modified Points from R2A20121SP

- The swing level of the maximum output voltage is changed from VREF to VCC.
- Ramp sloping compensation circuit is added.
- Synchronous rectification control is possible to turned off at light load. (only R2A20124AFP)
- On/off control terminal for Remote is added. (only R2A20124AFP)

Illustrative Circuit



Pin Arrangement

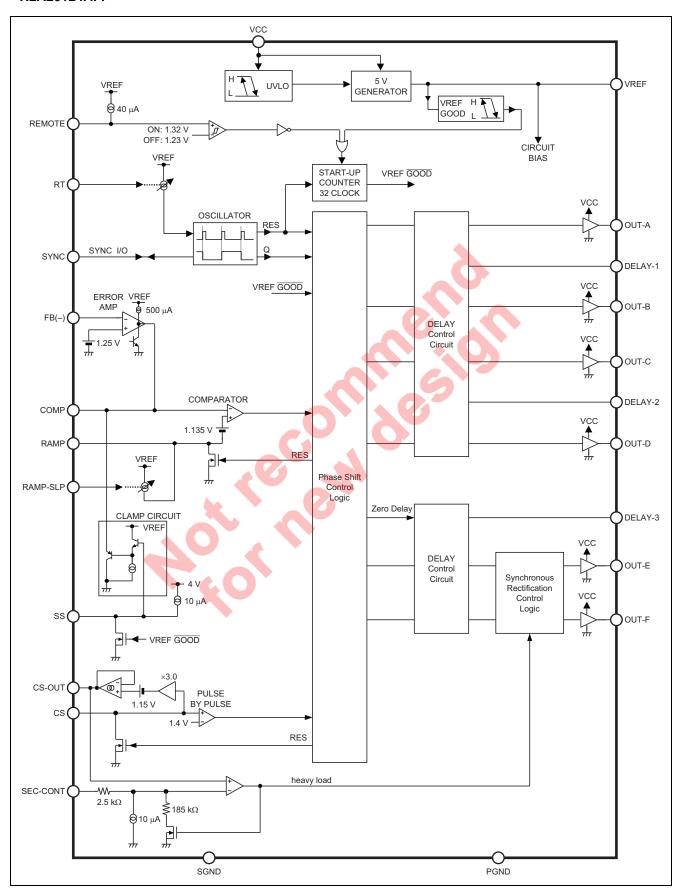


Pin Functions

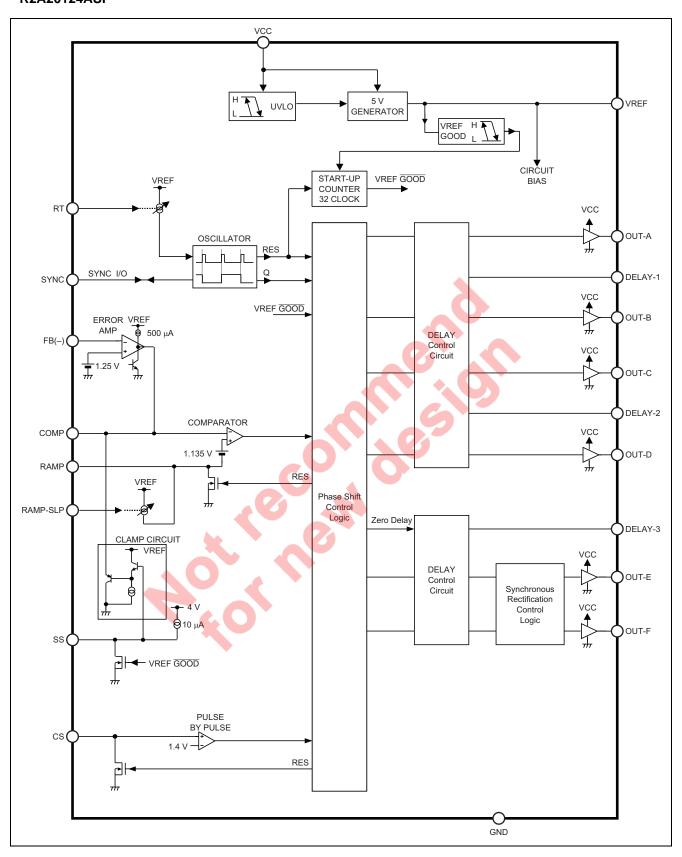
LQFP-40	SOP-20			
Pin No.	Pin No.	Pin Name	Input/Output	Pin Function
1	8	DELAY-1	Input/Output	Delay time adjustor for the full-bridge control signal (OUT-A and B)
2	9	DELAY-2	Input/Output	Delay time adjustor for the full-bridge control signal (OUT-C and D)
4	10	DELAY-3	Input/Output	Delay time adjustor for the secondary control signal (OUT-E and F)
5	_	SEC-CONT	Input	Synchronous rectification on/off control
6	_	REMOTE	Input	Remote on/off control
7	11	VREF	Output	5 V/20 mA output
9	12	VCC	Input	IC power supply input
13	13	OUT-F	Output	Secondary control signal
14	14	OUT-E	Output	Secondary control signal
17	15	OUT-D	Output	Full-bridge control signal
18	16	OUT-C	Output	Full-bridge control signal
19	17	OUT-B	Output	Full-bridge control signal
20	18	OUT-A	Output	Full-bridge control signal
22	_	PGND	_	Ground level for the output signal
23	_	SGND	_	Ground level for the small signal
_	19	GND	_	Ground
24	20	RT	Input/Output	Timing resistor for the oscillator
27	1	SYNC	Input/Output	Synchronization I/O for the oscillator
29	2	RAMP-SLP	Input/Output	Ramp sloping adjustor
31	3	RAMP	Input	Ramp waveform set
33	4	CS	Input	Current sense signal input for OCP
34	_	CS-OUT	Output	Current sense information amplifier output
36	5	COMP	Output	Error amplifier output
37	6	FB(-)	Input	Error amplifier negative input
38	7	SS	Output	Timing capacitor for soft start
3, 8,	_	N.C.		Open
10 to 12,				
15, 16,				Ø .
21, 25,				
26, 28,				
30, 32,				
35, 39,				
40		V 64		

Block Diagram

R2A20124AFP



R2A20124ASP



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit	Note
Power supply voltage	Vcc	20	V	1
Peak output current	lpk-out	±200	mA	2, 3
DC output current	Idc-out	±50	mA	3, 4
VREF output current	Iref-out	-20	mA	3
COMP sink current	Isink-comp	2	mA	3
DELAY set current	Iset-delay	0.3	mA	3
RT set current	Iset-rt	0.3	mA	3
RAMP-SLP set current	Iset-ramp-slp	0.3	mA	3
VREF terminal voltage	Vter-ref	-0.3 to +6	V	1, 5
Terminal group 1 voltage	Vter-1	-0.3 to (Vref + 0.3)	V	1, 6
Operating junction temperature	Tj-opr	-40 to +125	°C	7
Storage temperature	Tstg	−55 to +150	°C	

- Notes: 1. Rated voltages are with reference to the GND or SGND pin.
 - 2. The Rating shows the transient current when driving a capacitive load.
 - 3. For rated currents, inflow to the IC is indicated by (+), and outflow by (-).
 - 4. Total current of OUT-A, Out-B, OUT-C, OUT-D, OUT-E, and OUT-F must be not exceed ±90 mA.
 - 5. VREF pin voltage must not exceed VCC pin voltage.
 - 6. Terminal group 1 is defined the pins; REMOTE, RAMP-SLP, SEC-CONT, CS, RAMP, COMP, CS-OUT, FB(-), SS, RT, SYNC, and DELAY-1 to 3
 - 7. Theramal resistance θja R2A20124AFP (40-pin); 85.3°C/W Board condition; Glass epoxy 50 mm × 50 mm × 1.6 mm, 10% wiring density. R2A20124ASP (20-pin); 120°C/W Board condition; Glass epoxy 40 mm × 40 mm × 1.6 mm, 10% wiring density.



Electrical Characteristics

 $(Ta=25^{\circ}C,\,Vcc=12\,\,V,\,RT=180\,\,k\Omega,\,Rdelay=51\,\,k\Omega,\,Rramp-slp=27\,\,k\Omega,\,unless\,\,otherwise\,\,specified.)$

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
SUPPLY: R2A20124AFP/ASP						
Start threshold	VH	7.7	8.4	9.1	V	
Shutdown threshold	VL	7.4	8.0	8.6	V	
UVLO hysteresis	dVUVL	0.3	0.4	0.5	V	
Start-up current	Is	_	90	150	μΑ	Vcc = 7.5 V
Operating current	Icc	_	8	11.5	mA	No load on VREF pin
VREF: R2A20124AFP/ASP				•		
Output voltage	Vref	4.9	5.0	5.1	V	
Line regulation	Vref-line	_	0	10	mV	Vcc= 10 V to 16 V
Load regulation	Vref-load	_	6	20	mV	Iref= -1 mA to -20 mA
Temperature stability	dVref/dTa	_	±80*1	_	ppm/°C	Ta = -40°C to 105°C
OSCILLATOR: R2A20124AFP/ASP		•				
Oscillator frequency	fosc	_	200* ¹		kHz	
Switching frequency	fsw	85	100	115	kHz	Measured on OUT-A, -B
Line stability	fsw-line	-1.5	0	1.5	%	Vcc = 10 V to 16 V
Temperature stability	dfsw/dTa	_	±0.1* ¹	_(%/°C	Ta = -40°C to 105°C
RT voltage	V_{RT}	2.5	2.7	2.9	V	
SYNC: R2A20124AFP/ASP						
Input threshold	V _{TH-SYNC}	2.5	2.85	3.2	V	
Output high	V _{OH-SYNC}	3.5	4.0		V	RSYNC = 33 k Ω to GND * ²
Output low	V _{OL-SYNC}		0.10	0.18	V	RSYNC = $33 \text{ k}\Omega$ to VREF
Minimum input pulse	T _{I-MIN}	50	_		ns	
Output pulse width	T _{O-SYNC}		3.0* ¹		μS	
REMOTE: R2A20124AFP						
On threshold voltage	V _{ON-REMOTE}	1.12	1.32	1.52	V	
Off threshold voltage	V _{OFF-REMOTE}	1.04	1.23	1.42	V	
REMOTE hysteresis	dVREMOTE	60	90	120	mV	
Input bias current	І _{КЕМОТЕ}	-100	-50	_	μΑ	REMOTE = 2 V
ERROR AMPLIFIER: R2A20124AFP/	ASP					
FB(-) input voltage	V _{FB(-)}	1.225	1.250	1.275	V	FB(-) and COMP are shorted
FB(-) input current	I _{FB(-)}	-2.0	0	2.0	μΑ	FB(-) = 1.25 V
Open-loop DC gain	Av	_	80* ¹	_	dB	
Unity gain bandwidth	BW	_	2* ¹	_	MHz	
Output source current	I _{SOURCE}	-650	-500	-390	μΑ	FB(-) = 0.75 V, COMP = 2 V
Output sink current	I _{SINK}	2.0	6.5	_	mA	FB(-) = 1.75 V, COMP = 2 V
Output high voltage	V _{OH-EO}	3.7	3.9	_	V	FB(-) = 0.75 V, COMP; open
Output low voltage	V _{OL-EO}	_	0.1	0.4	V	FB(-) = 1.75 V, COMP; open
Output clamp voltage *3	V _{CLAMP-EO}	-0.16	-0.07	0.0	V	FB(-) = 0.75 V, COMP; open, SS = 1 V
Notes: 1. Design specification (refe	aronco data)				1	1

Notes: 1. Design specification (reference data)

2. R2A20124AFP: SGND and PGND

3. $V_{CLAMP-EO} = V_{COMP} - SS \text{ voltage (1 V)}$

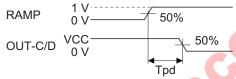
Electrical Characteristics (cont.)

(Ta = 25°C, Vcc = 12 V, RT = 180 kΩ, Rdelay = 51 kΩ, Rramp-slp = 27 kΩ, unless otherwise specified.)

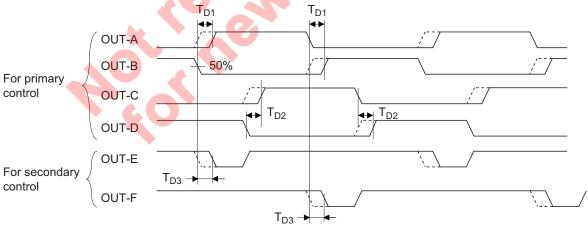
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
PHASE MODULATOR: R2A20124AFP/ASP						
RAMP offset voltage	V_{RAMP}	1.035	1.135	1.235	V	
RAMP source current	Isource-RAMP	-220	-185	-150	μΑ	RAMP = 0.15 V, COMP; open
RAMP sink current	I _{SINK-RAMP}	3	10	_	mA	RAMP = 0.15 V, COMP = 0 V
Minimum phase shift	Dmin	_	0*1*4	_	%	RAMP = 0 V, COMP = 0 V
Maximum phase shift	Dmax	_	97.0* ¹ * ⁴	_	%	RAMP = 0 V, COMP = 2.1 V
Delay to OUT-C, -D *2	Tpd	_	100	200	ns	COMP = 1.6 V
RAMP discharge time *1	Tdis	_	80	120	ns	FB(-) = 0.75 V, COMP; open
RAMP-SLP voltage	V _{RAMP-SLP}	2.1	2.3	2.5	V	
DELAY: R2A20124AFP/ASP						
DELAY-1, -2 * ³	T _{D1, 2}	70	100	130	ns	Delay set R = 51 k Ω
DELAY-3 *3	T _{D3}	45	65	85	ns	Delay set R = 51 k Ω
DELAY2-1, -2 * ¹ * ³	T _{D2_1, _2}	140	220	300	ns	Delay set R = 180 kΩ
DELAY2-3 * ¹ * ³	T _{D2_3}	110	170	230	ns	Delay set R = 180 kΩ
Terminal voltage	V _{D1, 2, 3}	1.9	2.0	2.1	V	Delay set R = 51 k Ω
SOFT START: R2A20124AFP/ASP						
Source current	I _{SS}	-14	-10	-6	μΑ	SS = 1 V
SS high voltage	V _{OH-SS}	3.9	4.0	4.1	٧	

Notes: 1. Design specification (reference data)

2. Tpd is defined as;



3. T_{D1} , T_{D2} , and T_{D3} are defined as;



4. Maximum/Minimum phase shift is defined as;

$$D = \frac{T2}{T1} \times 2 \times 100 \text{ (\%)}$$

$$OUT-A$$

$$OUT-D$$

$$T1$$

$$OUT-C$$

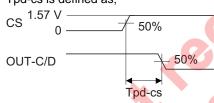
$$T1$$

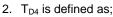
Electrical Characteristics (cont.)

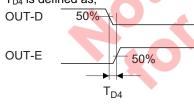
 $(Ta = 25^{\circ}C, Vcc = 12 \text{ V}, RT = 180 \text{ k}\Omega, Rdelay = 51 \text{ k}\Omega, Rramp-slp = 27 \text{ k}\Omega, unless otherwise specified.})$

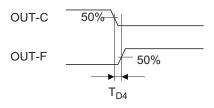
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
OVER CURRENT PROTECTION: R2A20124AFP/ASP						
Pulse-by-pulse current limit threshold	V _{CS-PP}	1.26	1.4	1.54	V	SEC-CONT = 0.3 V (AFP)
Delay to OUT pins *1	Tpd-cs	_	100	200	ns	CS = 0 V to 1.57 V, SEC-CONT = 0.3 V (AFP)
CS sink current	I _{SINK-CS}	2	5	_	mA	CS = 0.15 V, COMP = 0 V
OUTPUT: R2A20124AFP/ASP						
High voltage	V _{OH-OUT}	11.5	11.9		V	IOUT = −2 mA
Low voltage	$V_{OL\text{-}OUT}$	_	0.05	0.2	V	IOUT = 2 mA
Rise time	tr	_	30	100	ns	COUT = 100 pF
Fall time	tf	_	30	100	ns	COUT = 100 pF
Timing offset *2	T _{D4}	_	20	140	ns	
POWER INFORMATION AMPLIFIER	: R2A20124AFP					
Tranceconductance	gm	15	20	25	μs	CS = 0.4 V
SECONDARY CONTROL: R2A20124	1AFP					
Forced synchronous rectification on voltage	Von-sec-cont	4.6	_	3	V	CS = 1 V
Forced synchronous rectification off voltage	Voff-sec-cont	_		0.4	V	CS = 0 V
Input bias current-1	I _{SEC-CONT1}	5	10	20	μА	CS = 0 V, SEC-CONT = 2.1 V
Input bias current-2	I _{SEC-CONT2}	10	20	40	μΑ	CS = 1 V, SEC-CONT = 2.1 V
Current hysteresis	dI _{SEC-CONT}	5	10	20	μА	

Notes: 1. Tpd-cs is defined as;



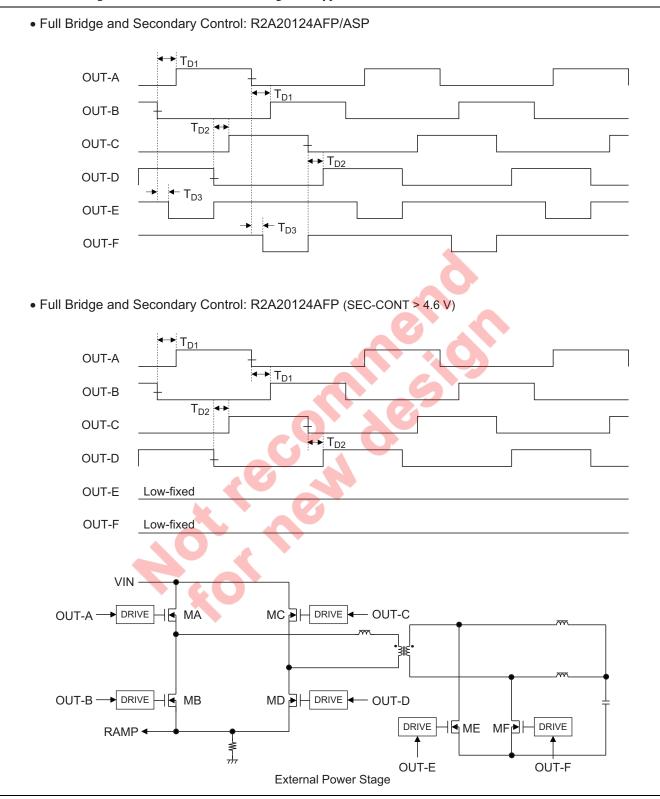




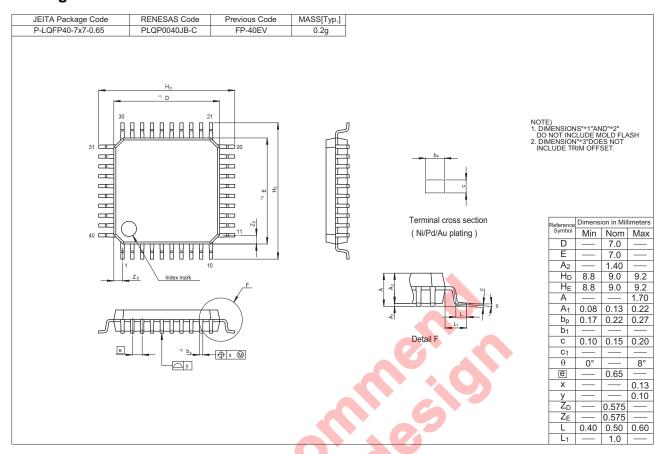


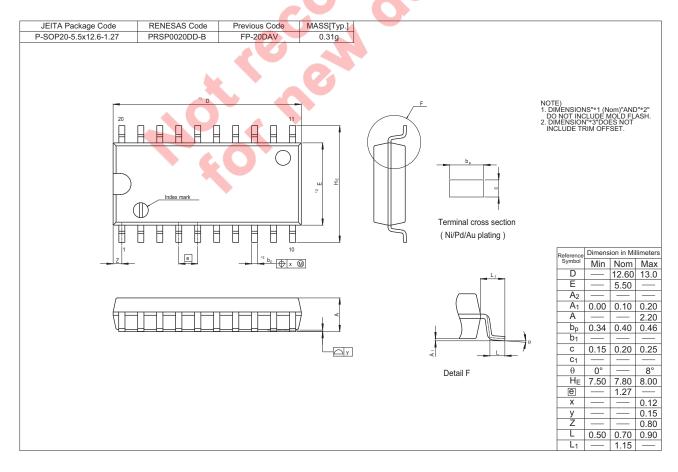
Timing Diagram

Note: All voltage, current, time shown in the diagram is typical value.



Package Dimensions





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enesas Electronics America Inc. 80 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A. dl: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited Dukes Meadow, Millboard Road, Boume End, Buckinghamshire, SL8 5FH, U.K Tel: +44-1628-585-100, Fax: +44-1628-585-900

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China
Tel: +86-10-2825-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 204, 205, AZIA Center, No. 1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China
Tel: +86-21-5877-1818, Fax: +86-21-5887-7589

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2868-9318, Fax: +852-2886-9022/9044

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei, Taiv Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

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